

产品规格书

Specification of products

产品名称:肖特基二极管

产品型号:MBK400U1K1

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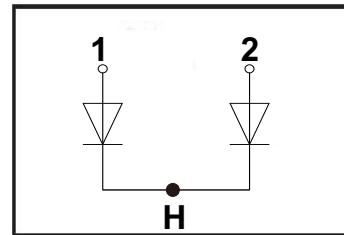
PRODUCT FEATURES

- Ultrafast Reverse Recovery Time
- Soft Reverse Recovery Characteristics
- Low Reverse Recovery Loss
- Low Forward Voltage
- High Surge Current Capability
- Low Inductance Package



APPLICATIONS

- Inversion Welder
- Uninterruptible Power Supply (UPS)
- Plating Power Supply
- Ultrasonic Cleaner and Welder
- Converter & Chopper
- Power Factor Correction (PFC) Circuit



ABSOLUTE MAXIMUM RATINGS

$T_c=25^{\circ}\text{C}$ unless otherwise specified

| Symbol | Parameter | Test Conditions | Values | Unit |
|-----------------|--------------------------------------|--|-------------|-----------------------------|
| V_R | Maximum D.C. Reverse Voltage | | 100 | V |
| V_{RRM} | Maximum Repetitive Reverse Voltage | | 100 | V |
| $I_{F(AV)}$ | Average Forward Current | $T_c=100^{\circ}\text{C}$, Per Diode | 200 | A |
| | | $T_c=100^{\circ}\text{C}$, Per Moudle | 400 | A |
| | | $T_c=100^{\circ}\text{C}$, 20KHz, Per Moudle | 280 | A |
| $I_{F(RMS)}$ | RMS Forward Current | $T_c=100^{\circ}\text{C}$, Per Diode | 280 | A |
| I_{FSM} | Non-Repetitive Surge Forward Current | 1/2 Cycle , 60Hz, Sine | 4000 | A |
| I^2t | I^2t (For Fusing) | $T_j=45^{\circ}\text{C}$, $t=8.3\text{ms}$, 60Hz, Sine | 11200 | A^2s |
| P_D | Power Dissipation | | 525 | W |
| T_j | Junction Temperature | | -40 to +150 | $^{\circ}\text{C}$ |
| T_{STG} | Storage Temperature Range | | -40 to +125 | $^{\circ}\text{C}$ |
| Torque | Module-to-Sink | Recommended (M6) | 3~4.7 | Nm |
| Torque | Module Electrodes | Recommended (M6) | 3~4.7 | Nm |
| $R_{\theta JC}$ | Thermal Resistance | Junction-to-Case | 0.20 | $^{\circ}\text{C}/\text{W}$ |
| Weight | | | 70 | g |

ELECTRICAL CHARACTERISTICS

$T_C=25^\circ\text{C}$ unless otherwise specified

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|----------|-------------------------|--|------|------|------|------|
| I_{RM} | Reverse Leakage Current | $V_R=100\text{V}$ | -- | -- | 0.5 | mA |
| | | $V_R=100\text{V}, T_J=125^\circ\text{C}$ | -- | -- | 10 | mA |
| V_F | Forward Voltage | $I_F=200\text{A}$ | -- | 0.65 | -- | V |
| | | $I_F=200\text{A}, T_J=125^\circ\text{C}$ | -- | 0.55 | -- | V |

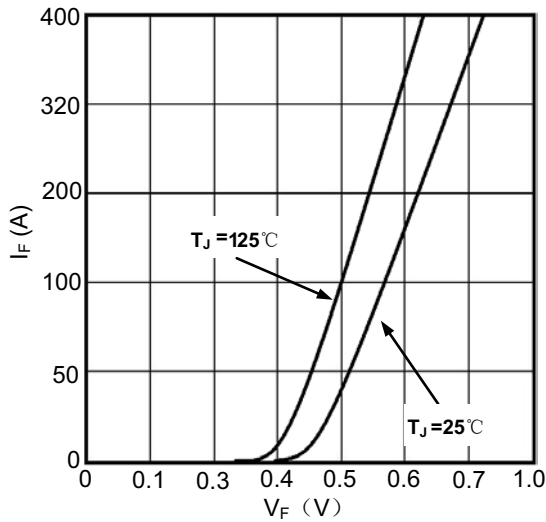


Figure1. Forward Voltage Drop vs Forward Current

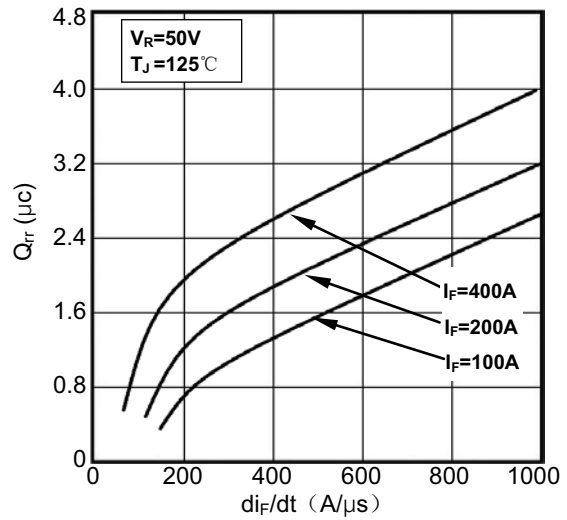


Figure2. Reverse Recovery Charge vs di_F/dt

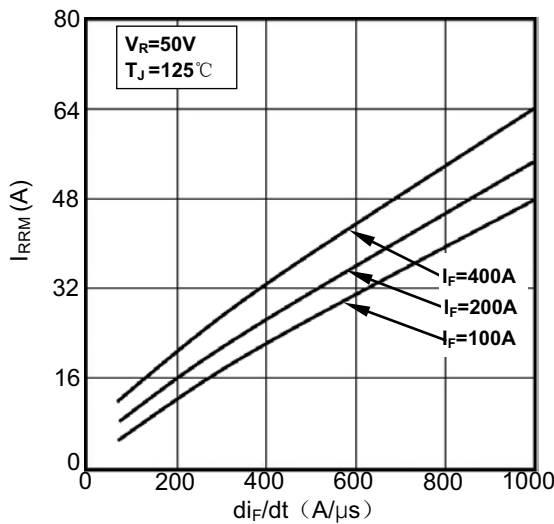


Figure3. Reverse Recovery Current vs di_F/dt

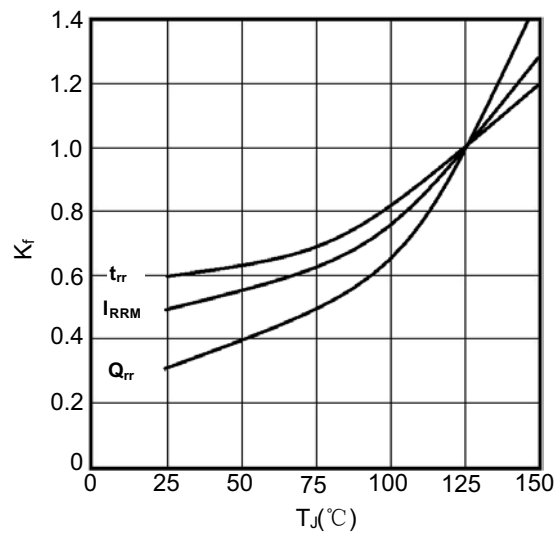
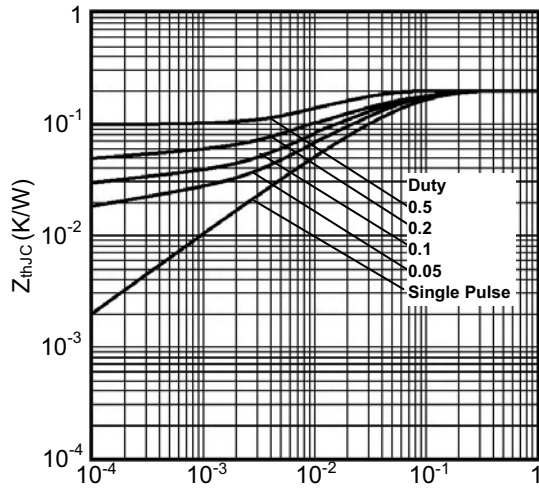
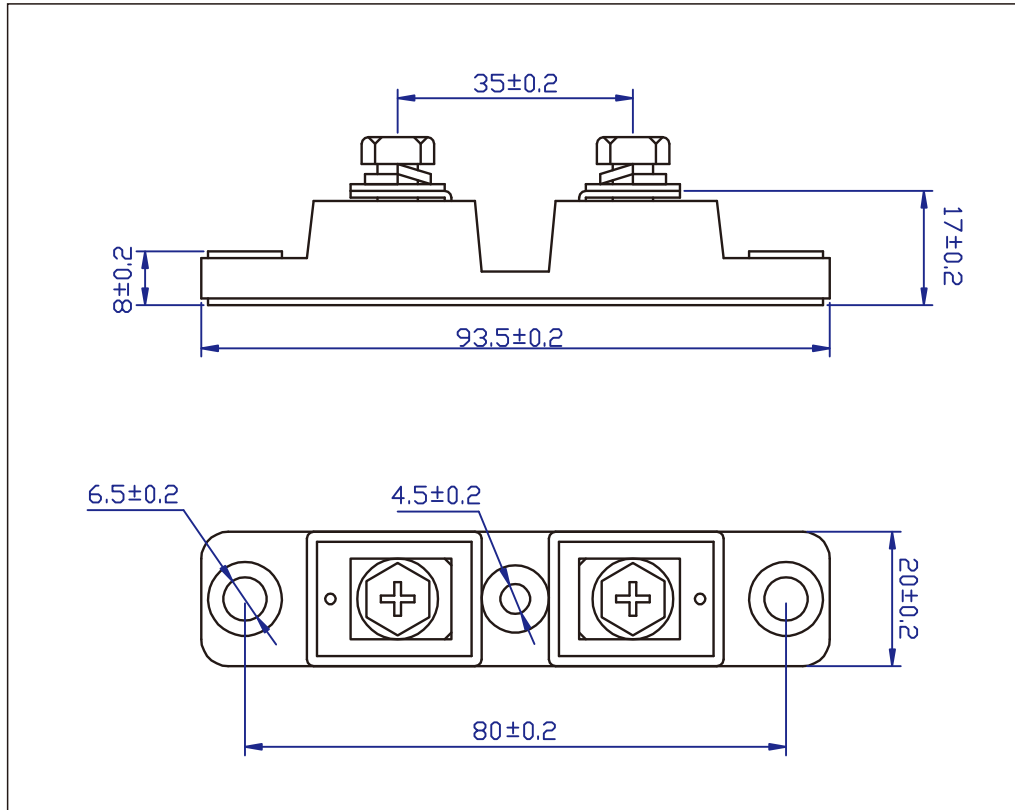


Figure4. Dynamic Parameters vs Junction Temperature



Rectangular Pulse Duration (seconds)
Figure 6. Transient Thermal Impedance

Package Outline



Dimensions (mm)